

Application Data Sheet

Application Information

Application Type:: Regular
Subject Matter:: Utility
Suggested Group Art Unit:: N/A
CD-ROM or CD-R?:: None
Sequence submission?:: None
Computer Readable Form (CRF)?:: No
Title:: METHOD OF FORMING METAL LINE OF SEMICONDUCTOR DEVICE
Attorney Docket Number:: 29936/39847
Request for Early Publication?:: No
Request for Non-Publication?:: No
Total Drawing Sheets:: 6
Small Entity?:: No
Petition included?:: No
Secrecy Order in Parent Appl.?:: No

Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Korea, Republic of
Status:: Full Capacity
Given Name:: Shin
Middle Name:: Seung
Family Name:: Park
City of Residence:: Kyungki-Do
Country of Residence:: Korea
Street of mailing address:: San 136-1, Ami-Ri, Bubal-Uep
Ichon-shi
City of mailing address:: Kyungki-Do
Country of mailing address:: Korea, Republic of

Correspondence Information

Correspondence Customer Number:: 04743

Representative Information

Representative Customer Number:: 04743

Foreign Priority Information

Country::	Application number::	FilingDate::	Priority Claimed::
Korea, Republic of	2003-21058	04/03/03	Yes

Assignee Information

Assignee name:: HYNIX SEMICONDUCTOR INC.
Street of mailing address:: San 136-1, Ami-Ri, Bubal-Uep, Ichon-Shi
City of mailing address:: Kyungki-Do
Country of mailing address:: Korea, Republic of
Postal or Zip Code of mailing address:: 467-860